

RV1S9262A

R08DS0274EJ0100

Rev.1.00

May 09, 2022

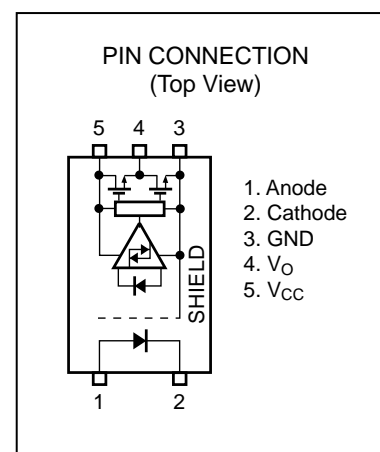
15 Mbps, HIGH CMTI, IPM DRIVER,
5-PIN SSOP WITH 8.2 mm CREEPAGE DISTANCE (LSSO5) PHOTOCOUPLER

DESCRIPTION

The RV1S9262A is a photocopler featuring high-speed switching up to 15 Mbps with active low output logic which consists of an AlGaAs LED on the input side and an integrated circuit with a photodiode on the output. The RV1S9262A is designed specifically for high common mode transient immunity (CMTI), wide operating power supply voltage range and high temperature operation up to $T_A = 125\text{ }^{\circ}\text{C}$. It is suitable for IPM (Intelligent Power Module) drive.

FEATURES

- Small and long creepage (8.2 mm, LSSO5)
- High speed switching (15 Mbps)
- High common mode transient immunity ($CM_H, CM_L = \pm 100\text{ kV}/\mu\text{s MIN.}$)
- Pulse width distortion ($|t_{PHL} - t_{PLH}| = 20\text{ ns MAX.}$)
- Wide operating power supply voltage range ($V_{CC} = 4.5 \sim 30\text{ V}$)
- Operating ambient temperature ($125\text{ }^{\circ}\text{C MAX.}$)
- High isolation voltage ($BV = 5\text{ }000\text{ Vr.m.s.}$)
- Embossed tape product : RV1S9262ACCSP-10Yx#KC0 : 3 500 pcs/reel
- Pb-Free product
- Safety standard
 - UL : UL1577, Double protection
 - CSA : CAN/CSA-C22.2 No.62368-1, Reinforced insulation
 - VDE : DIN EN 60747-5-5 (Option)

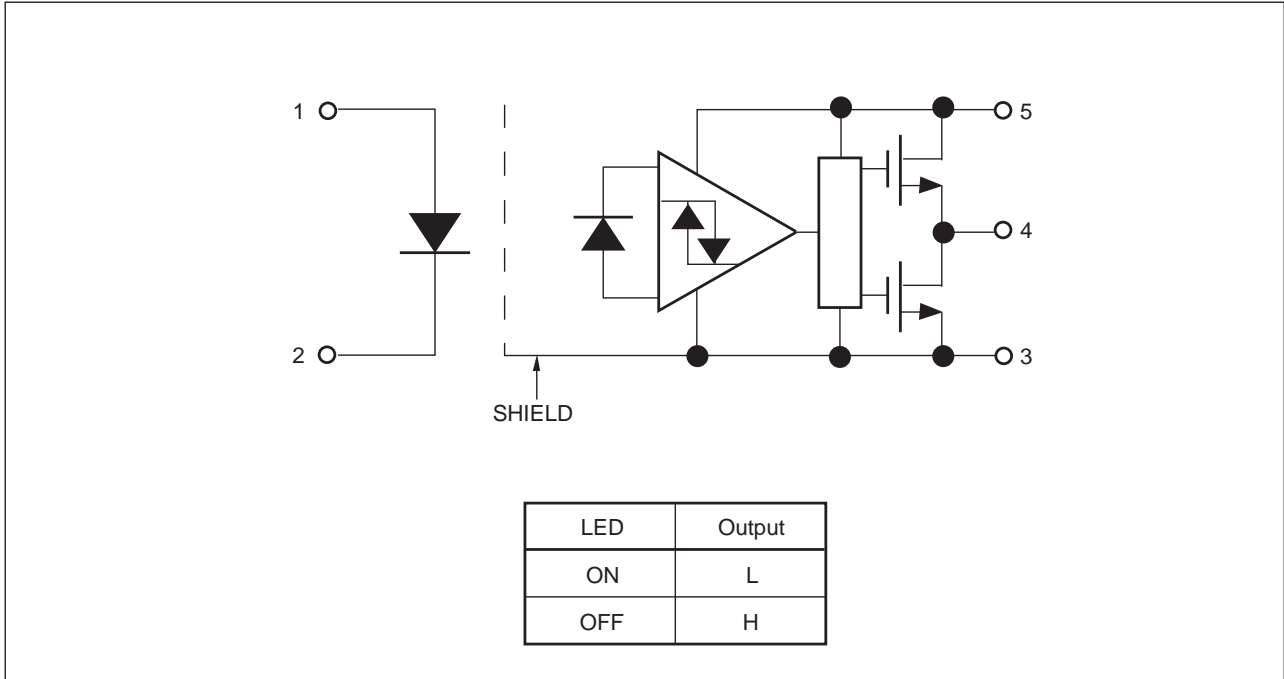


APPLICATIONS

- IPM driver
- General purpose inverter

Start of mass production
Apr. 2022

BLOCK DIAGRAM



MARKING EXAMPLE

○ R 9262
N744

| | | | |
|------|-----|-------------------------|---------------------------------|
| R | | An initial of “Renesas” | |
| 9262 | | Product Part Number * | |
| ○ | | No.1 pin Mark | |
| N744 | N | Rank Code | |
| | 744 | Assembly Lot | |
| | | 7 | Last one-digit of Assembly Year |
| | | 44 | Weekly Serial Code |

*) Applicable type numbers listed below
RV1S 9262 ACCSP-10Yx
Marking type number. "RV1S"and "ACCSP-10Yx" are omitted from original type number.

ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number *1 | |
|------------------------|----------------------------|---|---------------------------------|--|----------------------------|--|
| RV1S9262ACCSP -10YC | RV1S9262ACCSP -10YC#SC0 | Pb-Free and Halogen Free (Ni/Pd/Au) | 20 pcs (Tape 20 pcs cut) | Standard products (UL, CSA approved) | RV1S9262A | |
| | RV1S9262ACCSP -10YC#KC0 | | Embossed Tape 3 500 pcs/reel | | | |
| RV1S9262ACCSP -10YV | RV1S9262ACCSP -10YV#SC0 | | 20 pcs (Tape 20 pcs cut) | UL, CSA, DIN EN 60747-5-5 approved | | |
| | RV1S9262ACCSP -10YV#KC0 | | Embossed Tape 3 500 pcs/reel | | | |

Notes:*1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|-------------------------------|----------------------|-----------|------------------|--------------------|
| Diode | Forward Current | I_F | 20 | mA |
| | Reverse Voltage | V_R | 5 | V |
| | Power Dissipation *1 | P_D | 45 | mW |
| Detector | Supply Voltage | V_{CC} | -0.5 to +30 | V |
| | Output Voltage | V_O | -0.5 to V_{CC} | V |
| | Output Current | I_O | 25 | mA |
| | Power Dissipation *2 | P_C | 250 | mW |
| Isolation Voltage *3 | | BV | 5 000 | Vr.m.s. |
| Operating Ambient Temperature | | T_A | -40 to +125 | $^{\circ}\text{C}$ |
| Storage Temperature | | T_{stg} | -55 to +150 | $^{\circ}\text{C}$ |

Notes: *1. Reduced to 1.2 mW/ $^{\circ}\text{C}$ at $T_A = 110\text{ }^{\circ}\text{C}$ or more.

*2. Reduced to 4.15 mW/ $^{\circ}\text{C}$ at $T_A = 85\text{ }^{\circ}\text{C}$ or more.

*3. AC voltage for 1 minute at $T_A = 25\text{ }^{\circ}\text{C}$, RH = 60 % between input and output.

Pins 1-2 shorted together, 3-5 shorted together.

RECOMMENDED OPERATING CONDITIONS

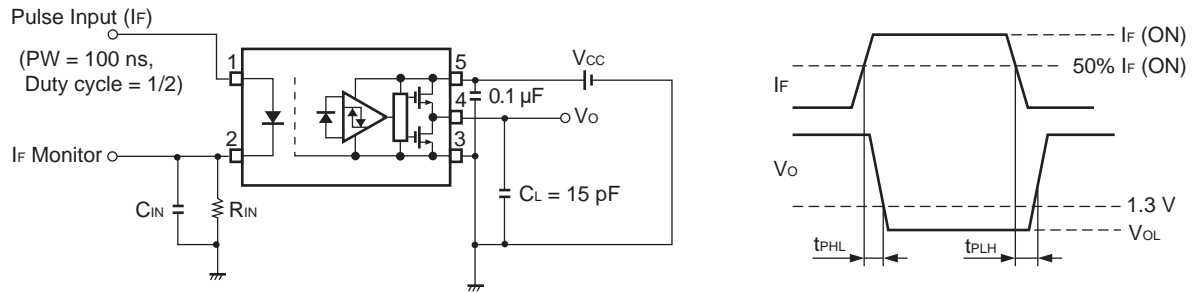
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|-------------------------------|-------------|------|------|------|--------------------|
| Supply Voltage | V_{CC} | 4.5 | | 30 | V |
| Forward Current (ON) | I_F (ON) | 6 | | 12 | mA |
| Forward Voltage (OFF) | V_F (OFF) | 0 | | 0.8 | V |
| Supply Voltage Ramp Slew Rate | SR | | | 0.5 | V/ μs |
| Operating Ambient Temperature | T_A | -40 | | 125 | $^{\circ}\text{C}$ |

ELECTRICAL CHARACTERISTICS (T_A = -40 to +125 °C, V_{CC} = 4.5 to 30 V)

| Parameter | | Symbol | Conditions | MIN. | TYP.*1 | MAX. | Unit |
|-----------|--|------------------------------------|---|----------------------|--------|------|-------|
| Diode | Forward Voltage | V _F | I _F = 6 mA, T _A = 25 °C | 1.4 | 1.54 | 1.7 | V |
| | Reverse Current | I _R | V _R = 3 V, T _A = 25 °C | | | 10 | μA |
| | Input Capacitance | C _i | V _F = 0 V, f = 1 MHz | | 30 | | pF |
| Detector | Low Level Output Voltage | V _{OL} | I _F = 6 mA, I _O = 3.5 mA | | | 0.3 | V |
| | | | I _F = 6 mA, I _O = 6.5 mA | | | 0.5 | |
| | High Level Output Voltage | V _{OH} | I _F = 0 mA, I _O = -3.5 mA | V _{CC} -1.5 | | | V |
| | | | I _F = 0 mA, I _O = -6.5 mA | V _{CC} -2.0 | | | |
| | Low Level Supply Current | I _{CCL} | I _F = 6 mA, V _{CC} = 30 V | | 1.7 | 3 | mA |
| | High Level Supply Current | I _{CCH} | I _F = 0 mA, V _{CC} = 30 V | | 1.7 | 3 | mA |
| | UVLO Threshold | V _{UVLO} | V _O < 1 V, I _F = 0 mA | | 3 | | V |
| Coupled | Threshold Input Current (H → L) | I _{FHL} | V _{CC} = 15 V, V _O < 0.3 V, I _O = 3.5 mA | | | 4 | mA |
| | Isolation Resistance | R _{I-O} | V _{I-O} = 1 kV dc, R _H ≤ 60 %, T _A = 25 °C | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V = 0 V, f = 1 MHz | | 0.6 | | pF |
| | Propagation Delay Time (H → L) *2 | t _{PHL} | V _{IN} = 0→5 V, C _{IN} = 60 pF, R _{IN} = 560 Ω, C _L = 15 pF, V _{THHL} = 1.3 V | | | 60 | ns |
| | Propagation Delay Time (L → H) *2 | t _{PLH} | V _{IN} = 5→0 V, C _{IN} = 60 pF, R _{IN} = 560 Ω, C _L = 15 pF, V _{THLH} = 1.3 V | | | 60 | ns |
| | Pulse Width Distortion (PWD) | t _{PHL} -t _{PLH} | V _{IN} = 0↔5 V, C _{IN} = 60 pF, R _{IN} = 560 Ω, C _L = 15 pF, V _{THHL} =V _{THLH} = 1.3 V | | | 20 | ns |
| | Propagation Delay Difference Between Any Two Parts (PDD) | | | | | 25 | |
| | Common Mode Transient Immunity at High Level Output *3 | CM _H | V _{CC} = 30 V, T _A = 25 °C, V _O > 17 V, I _F = 0 mA, V _{CM} = 1.5 kV | 100 | | | kV/μs |
| | Common Mode Transient Immunity at Low Level Output *3 | CM _L | V _{CC} = 30 V, T _A = 25 °C, V _O < 1 V, I _F = 6 mA, V _{CM} = 1.5 kV | 100 | | | kV/μs |

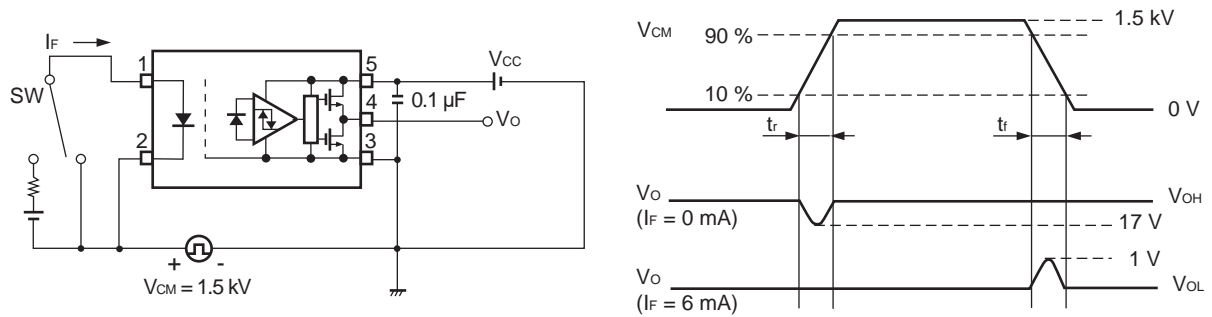
Notes: *1. Typical values at T_A = 25 °C.

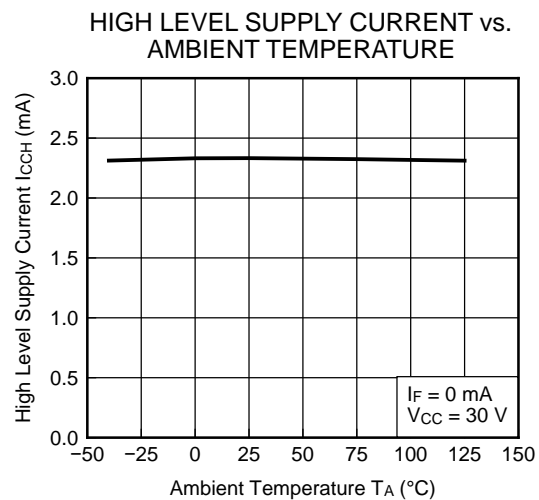
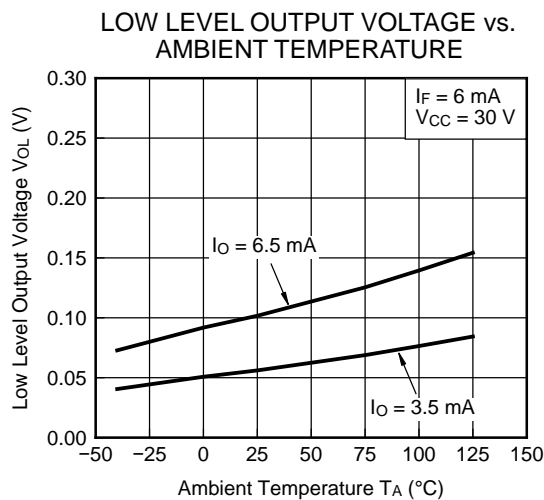
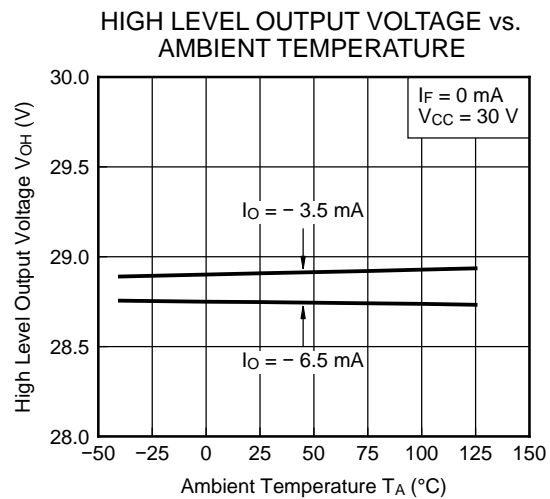
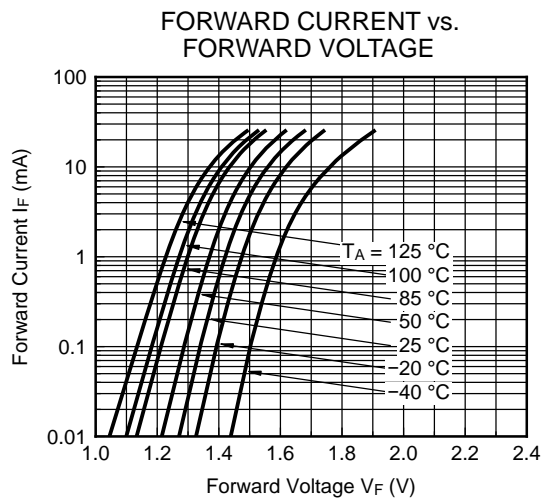
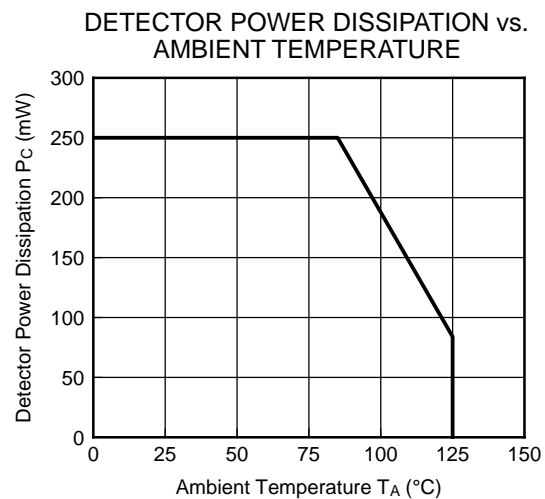
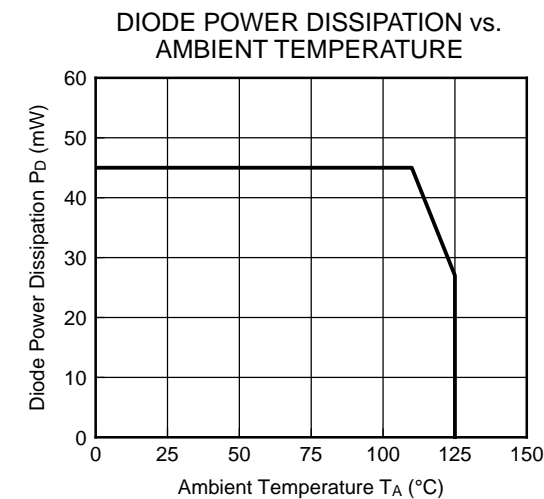
*2. Test circuit for propagation delay time



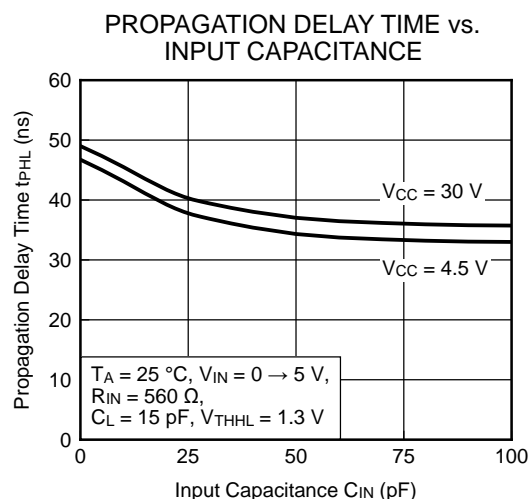
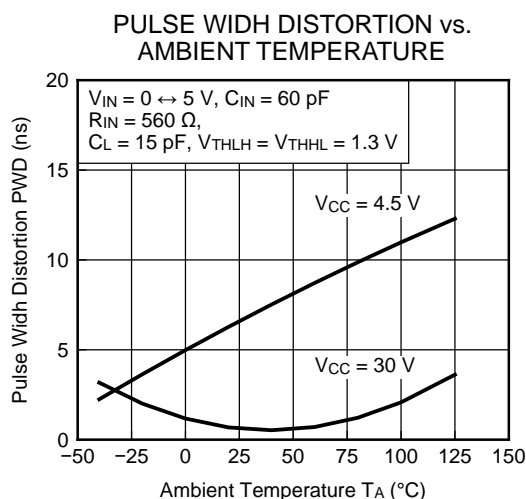
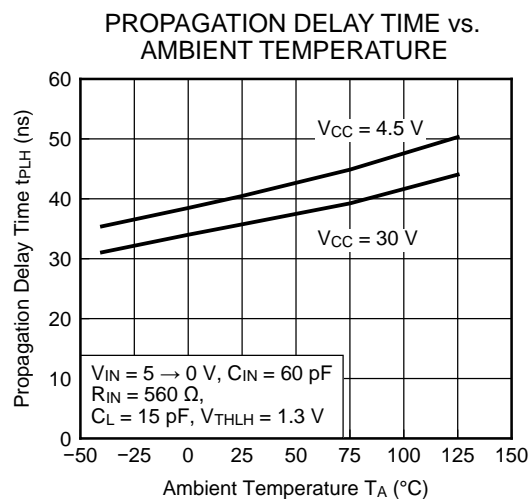
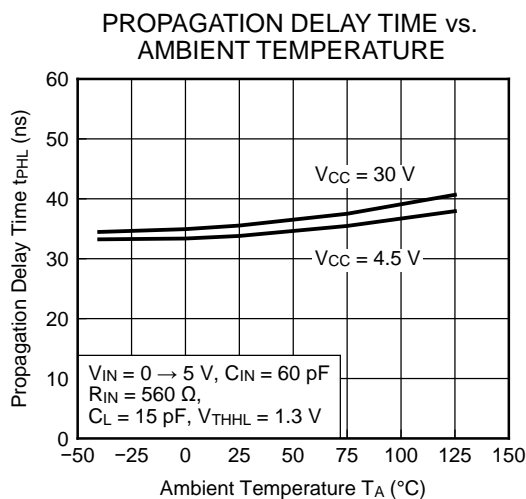
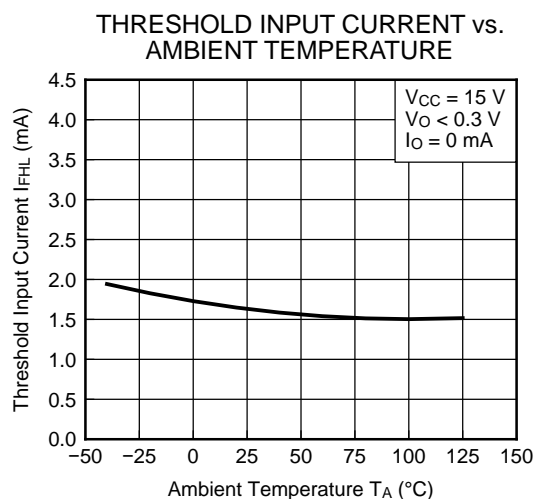
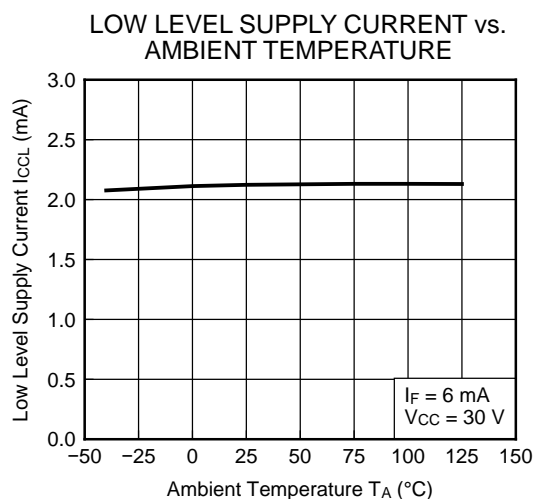
Remark C_L includes probe and stray wiring capacitance.

*3. Test circuit for common mode transient immunity

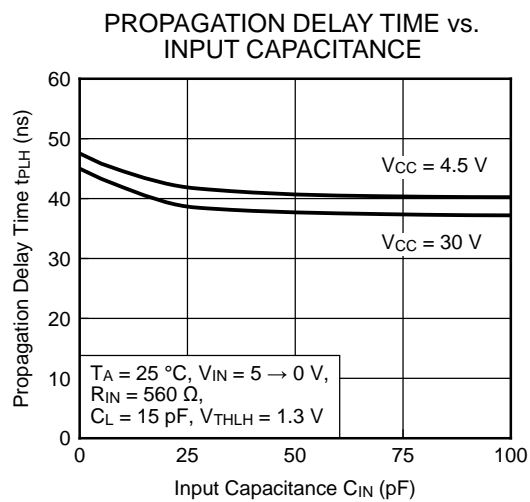


TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Remark The graphs indicate nominal characteristics.

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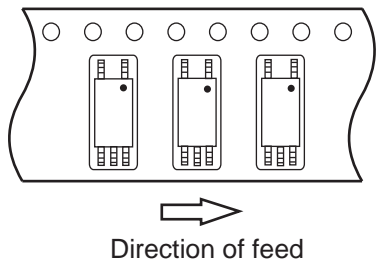
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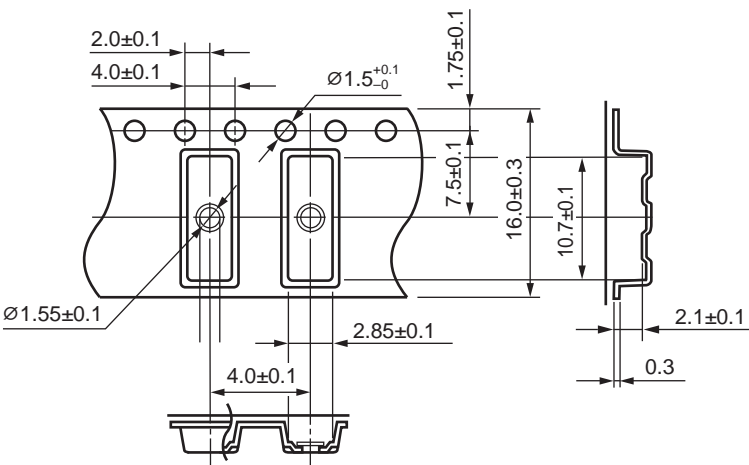
TAPING SPECIFICATIONS (UNIT : mm)

Tape Direction



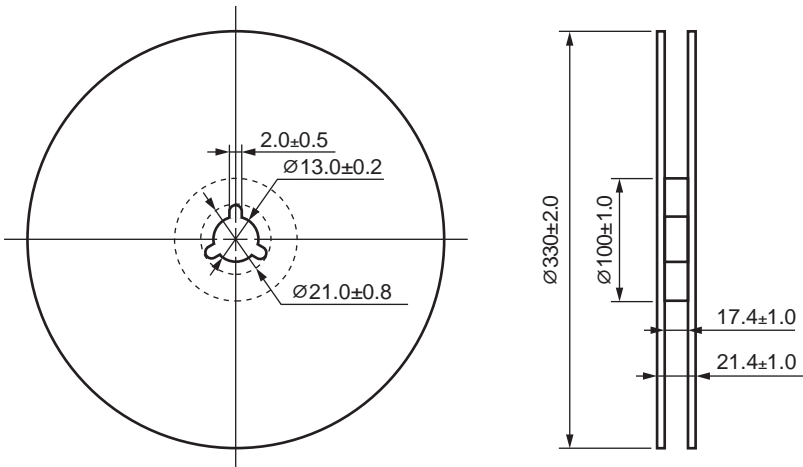
Outline and Dimensions (Tape)

(Unit : mm)



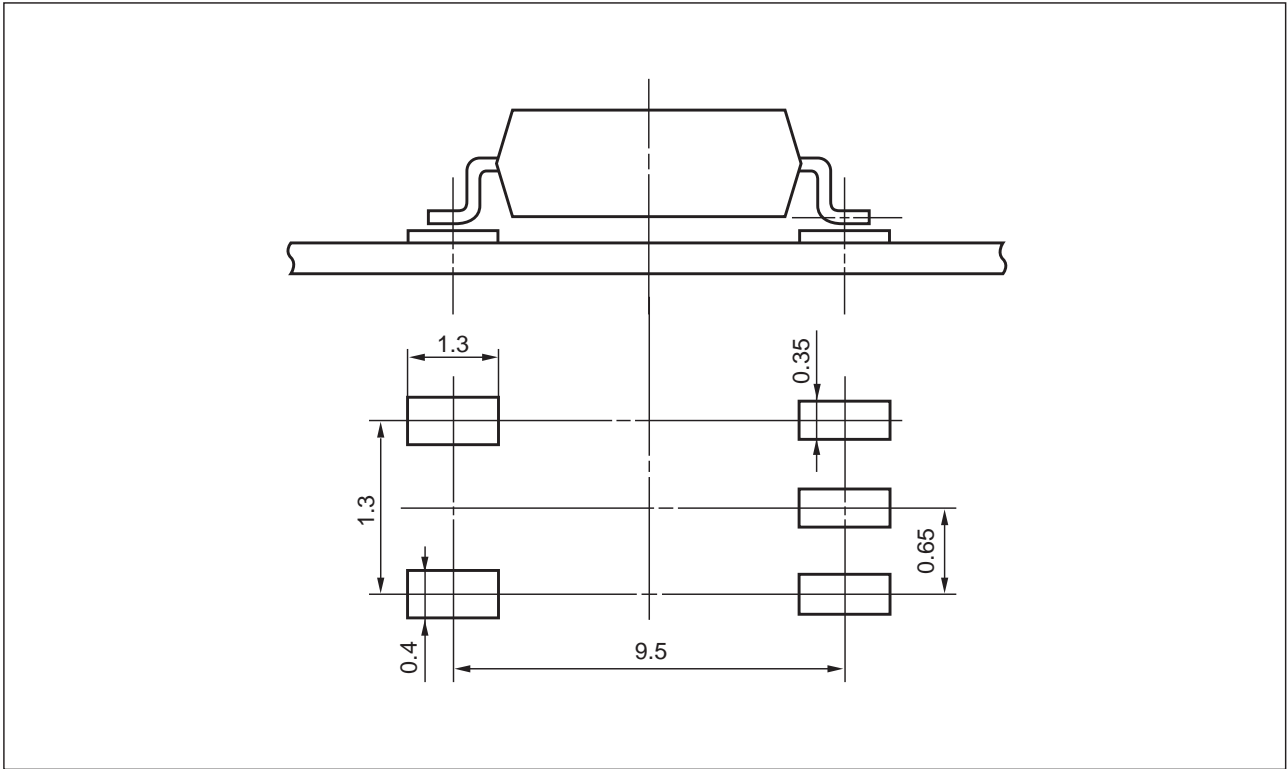
Outline and Dimensions (Reel)

(Unit : mm)



Packing: 3 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT : mm)



Remark All dimensions in this figure must be evaluated before use.

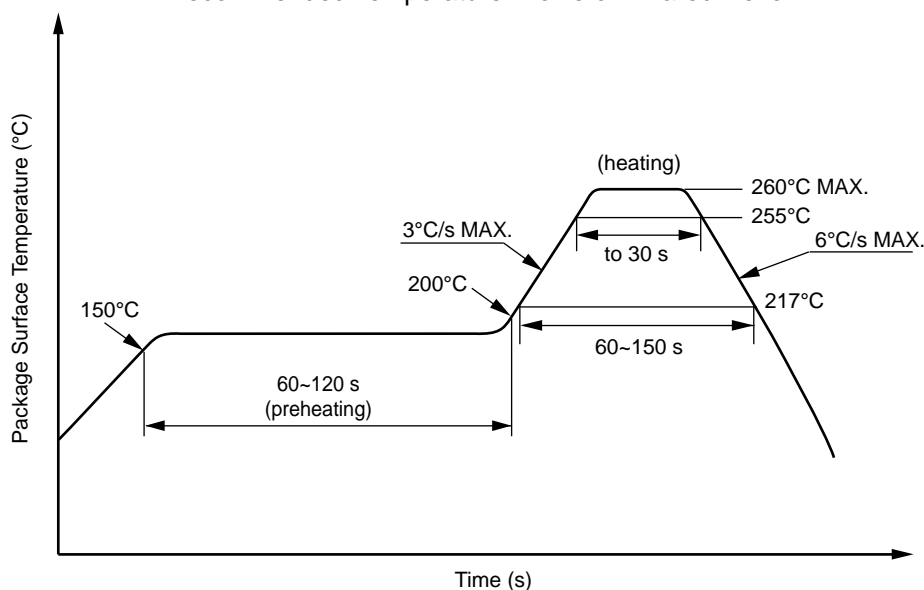
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- | | |
|--|---|
| • Peak reflow temperature | 260 °C or below (package surface temperature) |
| • Time of peak reflow temperature -5 °C (255 °C) | 30 seconds or less |
| • Time of temperature higher than 217 °C | 60~150 seconds |
| • Time to preheat temperature from 150 to 200 °C | 60~120 seconds |
| • Number of reflows | Three |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

Recommended Temperature Profile of Infrared Reflow



JEDEC J-STD-020D compliant soldering conditions

(2) Wave soldering

- | | |
|-------------------------|--|
| • Temperature | 260 °C or below (molten solder temperature) |
| • Time | 10 seconds or less |
| • Preheating conditions | 120 °C or below (package surface temperature) |
| • Number of times | One (Allowed to be dipped in solder including plastic mold portion.) |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

(3) Soldering by Soldering Iron

- | | |
|--|---|
| • Peak Temperature (lead part temperature) | 350 °C or below |
| • Time (each pins) | 3 seconds or less |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |
- Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

- Flux Cleaning
Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

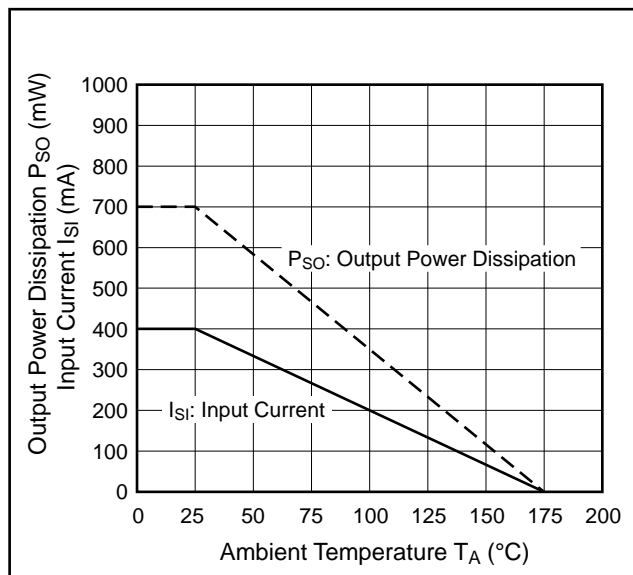
USAGE CAUTIONS

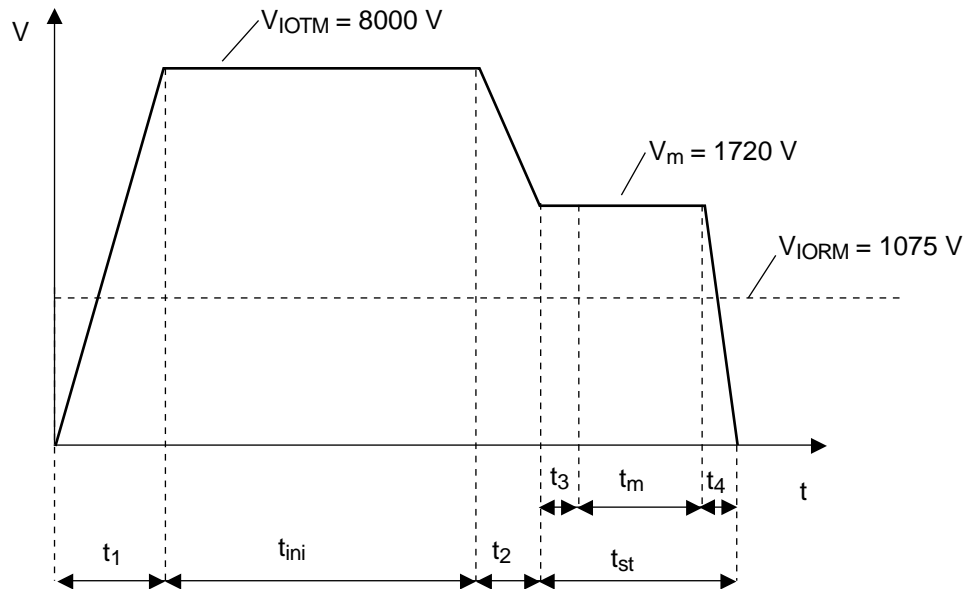
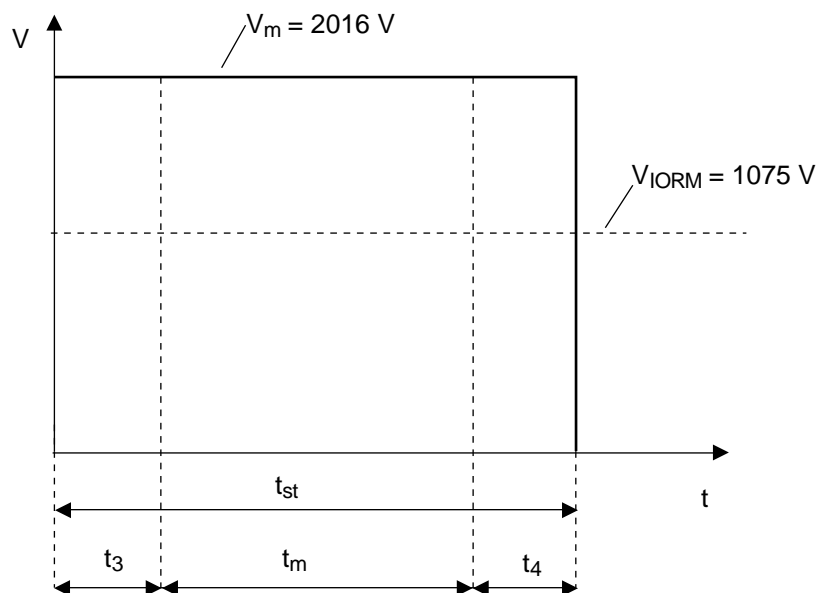
1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of more than 0.1 μF is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Rating | Unit |
|---|------------------------|-----------------|--------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/125/21 | |
| Dielectric strength | V_{IORM} | 1 075 | V_{peak} |
| maximum operating isolation voltage | V_m | 1 720 | V_{peak} |
| Test voltage (partial discharge test, procedure a for type test and random test) $V_m = 1.6 \times V_{IORM}$, $q_{pd} < 5 \text{ pC}$ | | | |
| Test voltage (partial discharge test, procedure b for all devices) $V_m = 1.875 \times V_{IORM}$, $q_{pd} < 5 \text{ pC}$ | V_m | 2 016 | V_{peak} |
| Highest permissible overvoltage | V_{IOTM} | 8 000 | V_{peak} |
| Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | 2 | |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11)) | CTI | 400 | |
| Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | II | |
| Storage temperature range | T_{stg} | $-55 \sim +150$ | $^{\circ}\text{C}$ |
| Operating temperature range | T_A | $-40 \sim +125$ | $^{\circ}\text{C}$ |
| Isolation resistance, minimum value $V_{I-O} = 500 \text{ V dc}$, $T_A = 25 \text{ }^{\circ}\text{C}$ | $R_{I-O} \text{ MIN.}$ | 10^{12} | Ω |
| $V_{I-O} = 500 \text{ V dc}$, $T_A = \text{maximum temperature of rating, at least } 100 \text{ }^{\circ}\text{C}$ | $R_{I-O} \text{ MIN.}$ | 10^{11} | Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) | | | |
| Maximum ambient temperature | T_S | 175 | $^{\circ}\text{C}$ |
| Maximum input current | I_{SI} | 400 | mA |
| Maximum output power dissipation | P_{SO} | 700 | mW |
| Isolation resistance, minimum value at $V_{I-O} = 500 \text{ V dc}$, $T_A = T_S$ | $R_{I-O} \text{ MIN.}$ | 10^9 | Ω |

Dependence of maximum safety ratings on ambient temperature



Method a) Destructive Test, Type and Sample Test**Method b) Non-destructive Test, 100% Production Test**

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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(Rev.5.0-1 October 2020)

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